

# CMPA0560008S

## 0.5 - 6 GHz, 10 W GaN HPA

### **Description**

The CMPA0560008S is a 10W packaged MMIC HPA utilizing the high performance, 0.15um GaN on SiC production process. The CMPA0560008S operates from 0.5-6 GHz and supports a variety of RF applications such as electronic warfare, test and measurement, radar among others. The CMPA0560008S achieves 10 W of saturated output power with 12 dB of large signal gain and typically 40% power-added efficiency under CW operation.

Packaged in a 5x5 mm plastic overmold QFN, the CMPA0560008S provides superior performance and environmental robustness in a small form factor allowing customers to improve SWaP-C benchmarks in their next-generation systems.



**Figure 1. CMPA0560008S** 

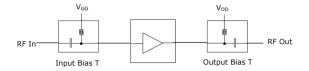


Figure 2. Functional Block Diagram

#### **Features**

Psat: 10 W
PAE: 40 %
LSG: 12 dB
S21: 19 dB
S11: -11 dB
S22: -8 dB
CW operation

• Small 5 x 5 mm footprint

Note: Features are typical performance across frequency under 25C operation. Please reference performance charts for additional information.

### **Applications**

- Electronic Warfare
- Test and Measurement
- Radar
- General Amplification



### **Absolute Maximum Ratings**

Parameter	Symbol	Units	Value	Conditions
Drain Voltage	$V_d$	V	28	
Gate Voltage	$V_{g}$	V	-10, +2	
Drain Current	I <sub>d</sub>	Α	1.3	
Gate Current	l <sub>g</sub>	mA	3.8	
Input Power	P <sub>in</sub>	dBm	29	
Dissipated Power	P <sub>diss</sub>	W	25	85°C
Storage Temperature	$T_{stg}$	°C	-55, +150	
Mounting Temperature	TJ	°C	260	30 seconds
Junction Temperature	TJ	°C	225	
Output Mismatch Stress	VSWR	Ψ	5:1	

### **Recommended Operating Conditions**

Parameter	Symbol	Units	Typical Value	Conditions
Drain Voltage	Vd	V	28	
Gate Voltage	Vg	V	-2.0	
Drain Current	Idq	mA	220	
Input Power	Pin	dBm	28	
Case Temperature	Tcase	°C	-40 to 85	

### **RF Specifications**

Test conditions unless otherwise noted: Vd=28V, Idq=220mA, CW,  $T_{base}=25$   $^{\circ}C$ 

Parameter	Units	Frequency	Min	Typical	Max	Conditions
Frequency	GHz		0.5		6	
		0.5		40		
Output Power	dBm	3		40		Pin = 28 dBm
		6		40		
Dawar addad		0.5		60		
Power-added Efficiency	%	3		44		Pin = 28 dBm
		6		36		
LSG	dB	0.5		12		Pin = 28 dBm
		3		12		
		6		12		
Small-Signal Gain (S21)	n dB	0.5		21		
		3		19		Pin = -20 dBm
		6		19		
Input Return Loss	dB			-11		Pin = -20 dBm
Output Return Loss	dB			-8		Pin = -20 dBm

Figure 3: Pout v. Frequency v. Temperature

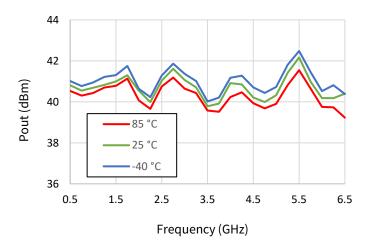


Figure 4: PAE v. Frequency v. Temperature

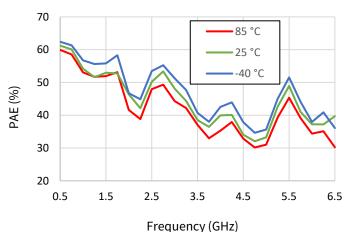


Figure 5: Id v. Frequency v. Temperature

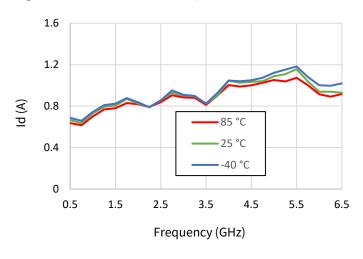


Figure 6: Ig v. Frequency v. Temperature

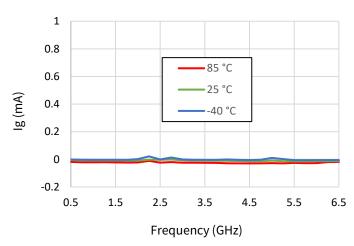


Figure 7: LSG v. Frequency v. Temperature

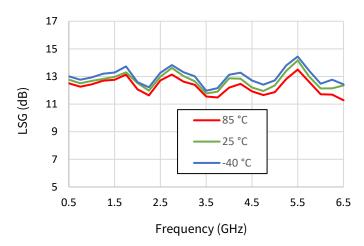


Figure 8: Pout v. Frequency v. Vd

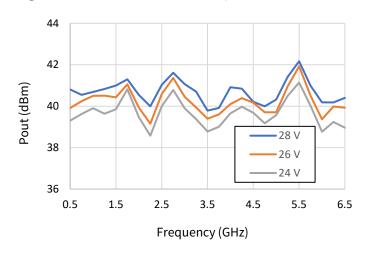


Figure 9: PAE v. Frequency v. Vd

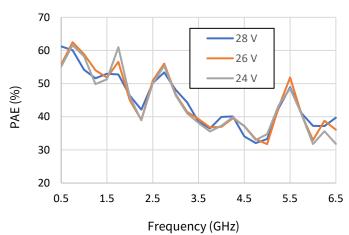


Figure 10: Id v. Frequency v. Vd

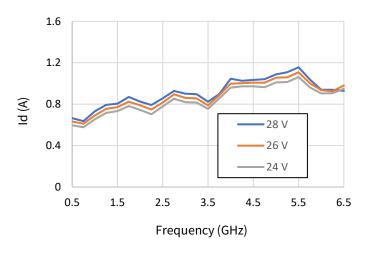


Figure 11: Ig v. Frequency v. Vd

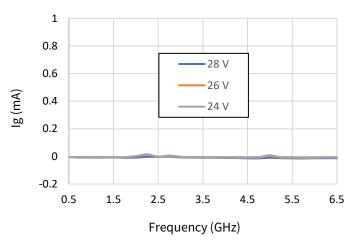


Figure 12: LSG v. Frequency v. Vd

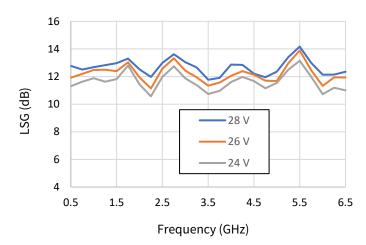


Figure 13: Pout v. Frequency v. Idq

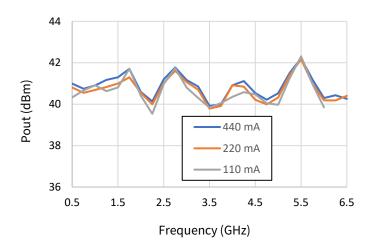


Figure 14: PAE v. Frequency v. Idq

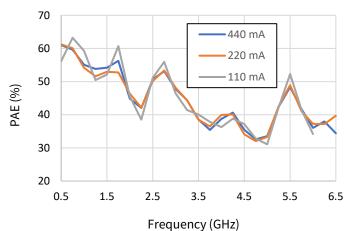


Figure 15: Id v. Frequency v. Idq

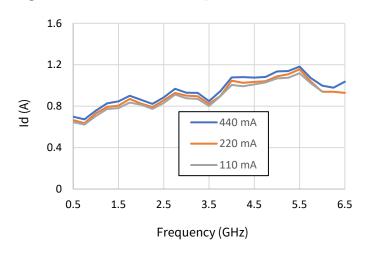


Figure 16: Ig v. Frequency v. Idq

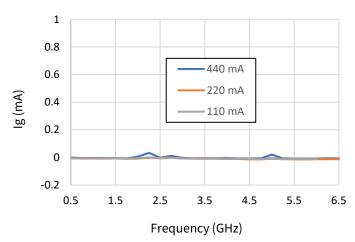


Figure 17: LSG v. Frequency v. Idq

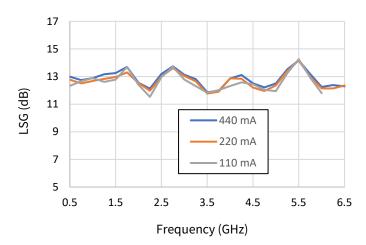


Figure 18: Pout v. Pin v. Frequency

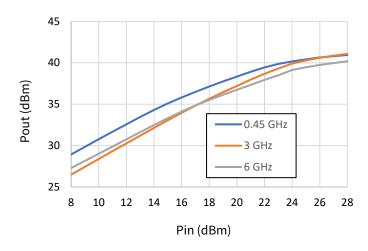


Figure 19: PAE v. Pin v. Frequency

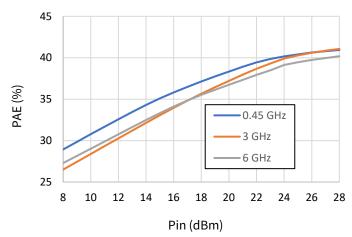


Figure 20: Id v. Pin v. Frequency

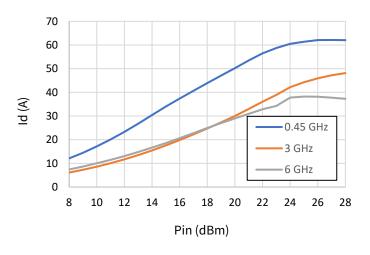


Figure 21: Ig v. Pin v. Frequency

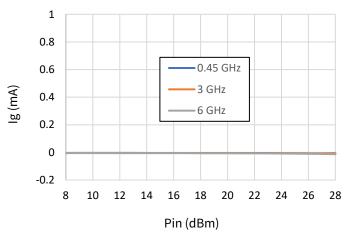


Figure 22: Gain v. Pin v. Frequency

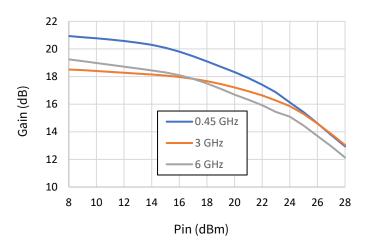


Figure 23: Pout v. Pin v. Temperature

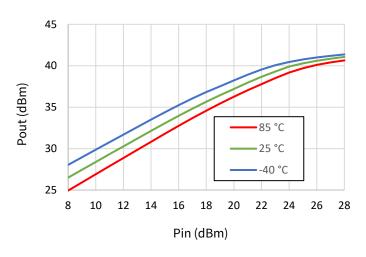


Figure 24: PAE v. Pin v. Temperature

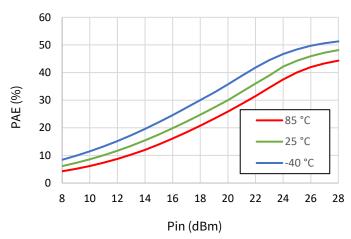


Figure 25: Id v. Pin v. Temperature

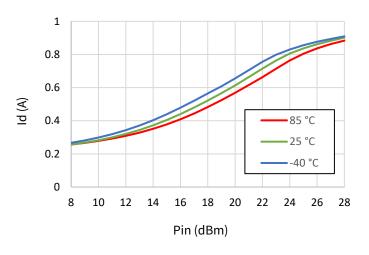


Figure 26: Ig v. Pin v. Temperature

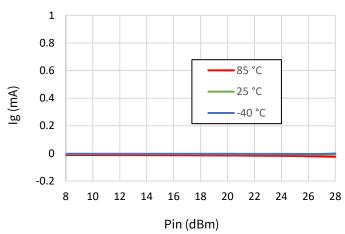


Figure 27: Gain v. Pin v. Temperature

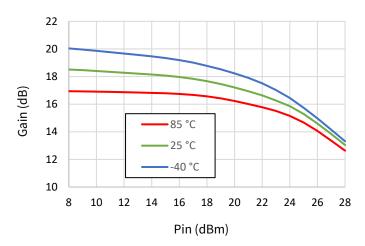


Figure 28: Pout v. Pin v. Vd

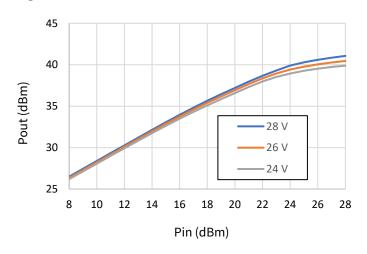


Figure 29: PAE v. Pin v. Vd

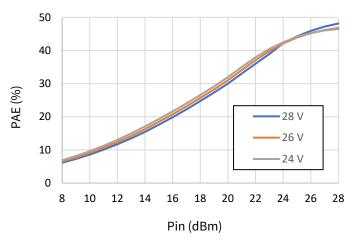


Figure 30: Id v. Pin v. Vd

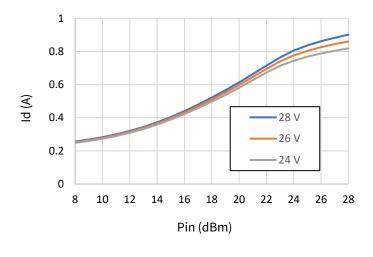


Figure 31: Ig v. Pin v. Vd

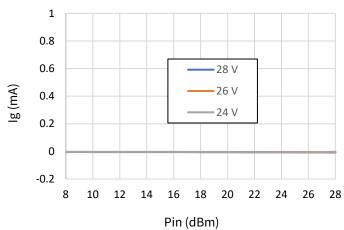


Figure 32: Gain v. Pin v. Vd

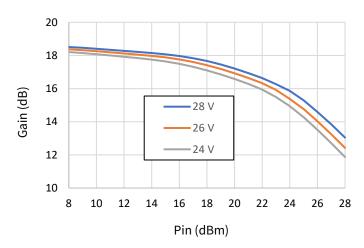


Figure 33: Pout v. Pin v. Idq

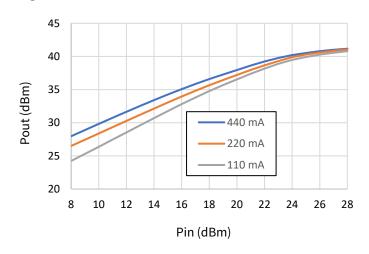


Figure 34: PAE v. Pin v. Idq

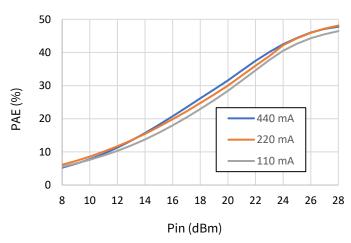


Figure 35: Id v. Pin v. Idq

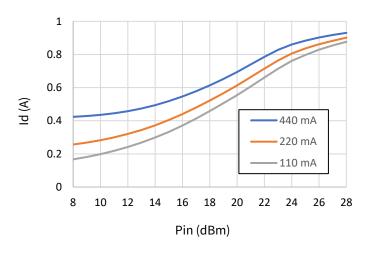


Figure 36: Ig v. Pin v. Idq

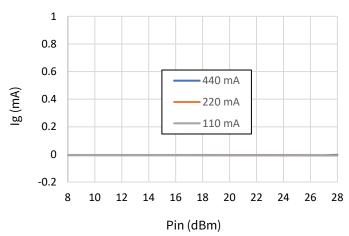
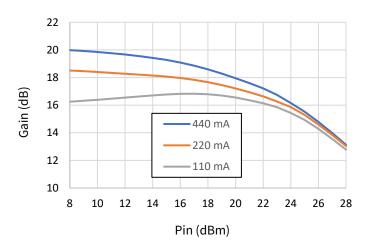


Figure 37: Gain v. Pin v. Idq



Test conditions unless otherwise noted: Vd=28 V, Idq=0.220A, CW, Pin = -10 dBm, T<sub>base</sub>=25 °C

Figure 38: S21 v. Frequency v. Temperature

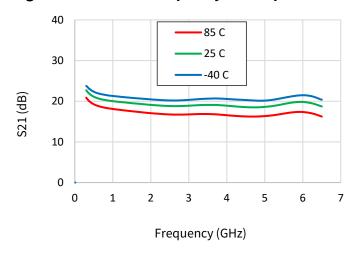


Figure 39: S21 v. Frequency v. Vd

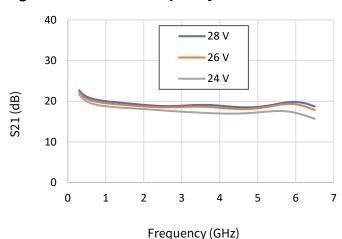


Figure 40: S11 v. Frequency v. Temperature

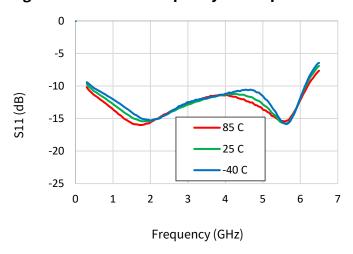


Figure 41: S11 v. Frequency v. Vd

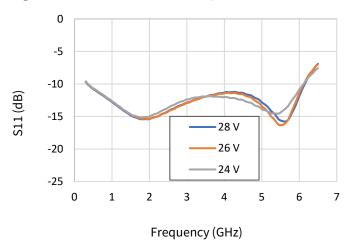


Figure 42: S22 v. Frequency v. Temperature

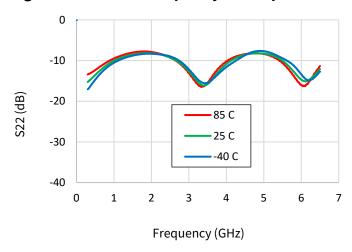
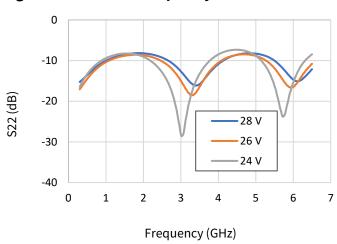


Figure 43: S22 v. Frequency v. Vd



Test conditions unless otherwise noted: Vd=28 V, Idq=0.220A, CW, Pin = -10 dBm, T<sub>base</sub>=25 °C

Figure 44: S21 v. Frequency v. Idq

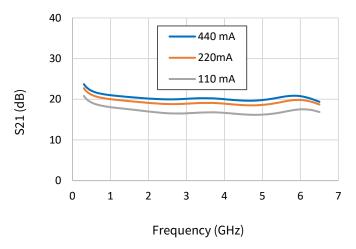


Figure 45: \$11 v. Frequency v. Idq

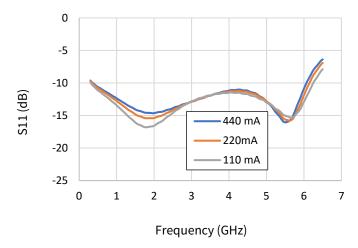
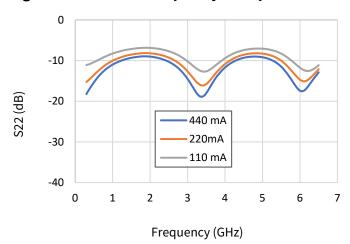


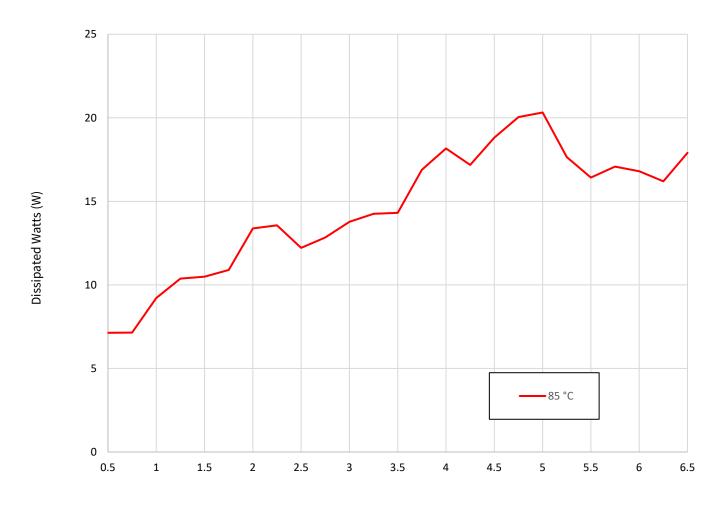
Figure 46: S22 v. Frequency v. Idq



### **Thermal Characteristics**

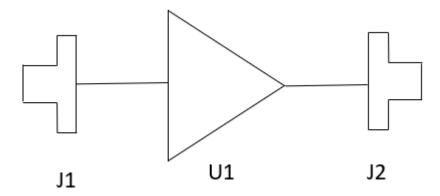
Parameter	Symbol	Value	Operating Conditions
Operating Junction Temperature	$T_J$	131°C	Freq = 3.0 GHz, $V_d = 28 \text{ V}$ , $I_{dq} = 220 \text{ mA}$ , $I_{drive} = 0.88 \text{ A}$ ,
Thermal Resistance, Junction to Case	$R_{ heta JC}$	3.3°C/W	- P <sub>in</sub> = 28 dBm, P <sub>out</sub> = 40.6 dBm, P <sub>diss</sub> = 13.8 W, T <sub>case</sub> = 85°C, CW

## Power Dissipation v. Frequency (Tcase = 85°C)



Frequency (GHz)

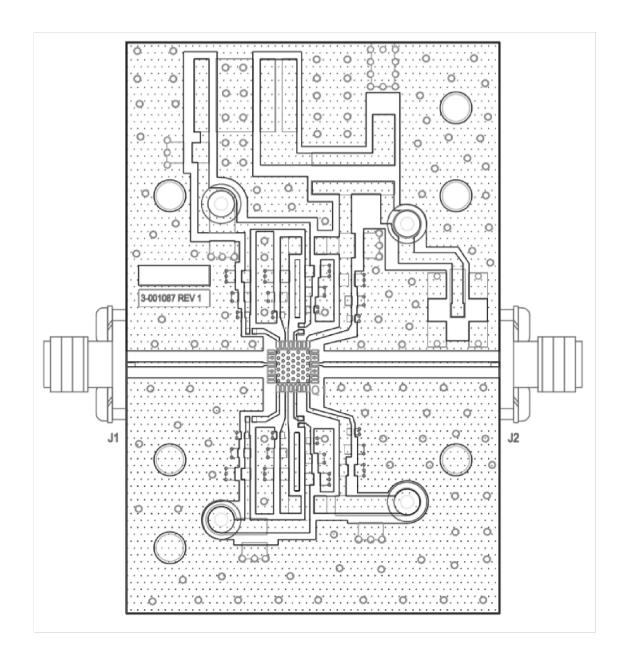
### **CMPA0560008S-AMP1 Evaluation Board Schematic Drawing**



### CMPA0560008S-AMP1 Evaluation Board Bill of Materials

Reference Designator	Description	Qty
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
U1	CMPA0560008S	1
-	PCB, TEST FIXTURE, RF35, 0.010", 5X5 2-STAGE, QFN	1
-	2-56 SOC HD SCREW 3/16 SS	4
-	#2 SPLIT LOCKWASHER SS	4

### CMPA0560008S-AMP1 Evaluation Board Assembly Drawing



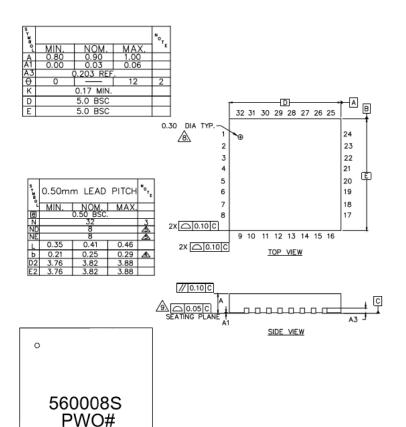
#### **Bias On Sequence**

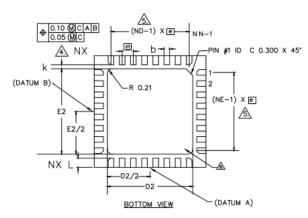
- 1. Ensure RF is turned-off
- 2. Apply pinch-off voltage of -5 V to the gate (Vg)
- 3. Apply nominal drain voltage (Vd)
- 4. Adjust Vg to obtain desired quiescent drain current (Idq)
- 5. Apply RF

### **Bias Off Sequence**

- 1. Turn RF off
- 2. Apply pinch-off to the gate (Vg=-5V)
- 3. Turn off drain voltage (Vd)
- 4. Turn off gate voltage (Vg)

#### **Product Dimensions**





#### NOTES :

- O'LES :

  1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M. 1994.

  2. ALL DIMENSIONS ARE IN MILLIMETERS, 0 IS IN DEGREES.

  3. N IS THE TOTAL NUMBER OF TERMINALS.

  ADMINISTROON 6 APPUES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL TIP.
- ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.

  MAX. PACKAGE WARPAGE IS 0.05 mm.

  MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.

- A PIN #1 ID ON TOP WILL BE LASER MARKED.
- 9. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

  10. THIS DRAWING CONFORMS TO JEDEC REGISTERED OUTLINE MO-220

  11. ALL PLATED SURFACES ARE 100% TIN MATTE 0.010 mm +/- 0.005 mm.

PIN	DESC.	PIN	DESC
1	NC	17	NC
2	NC	18	NC
3	RFGND	19	NC
4	RFIN / Vg	20	RFGND
5	RFGND	21	RFOUT / Vd
6	NC	22	RFGND
7	NC	23	NC
8	NC	24	NC
9	NC	25	NC
10	NC	26	NC
11	NC	27	NC
12	NC	28	NC
13	NC	29	NC
14	NC	30	NC
15	NC	31	NC
16	NC	32	NC

## **Electrostatic Discharge (ESD) Classification**

Parameter	Symbol	Class	Classification Level	Test Methodology
Human body Model	HBM	TBD	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	TBD	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C

# **Product Ordering Information**

Part Number	Description	MOQ Increment	Image
CMPA0560008S	0.5 – 6 GHz, 10W GaN MMIC		Campage Little Hill
CMPA0560008S-AMP1	Evaluation Board w/ PA	1 Each	

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